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Silicon P-Channel MOS FET



ADE-208-1191 (Z) 1st. Edition Mar. 2001

Application

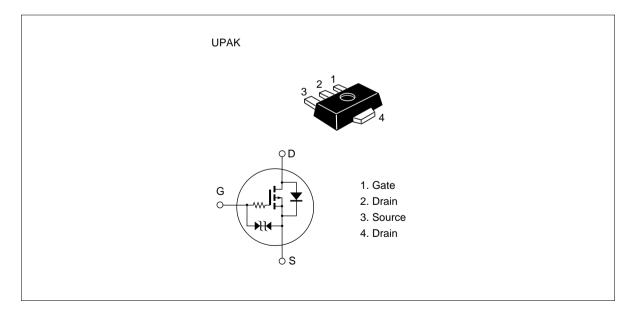
High speed power switching

Low voltage operation

Features

- Very low on-resistance
- High speed switching
- Suitable for camera or VTR motor drive circuit, power switch, solenoid drive and etc.

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	-12	V
Gate to source voltage	V _{GSS}	-7	V
Drain current	I _D	<u>+2</u>	A
Drain peak current	I *1 D(pulse)	±4	A
Body to drain diode reverse drain current	I _{DR}	2	А
Channel dissipation	Pch*2	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 100 \ \mu s$, duty cycle $\le 10\%$

2. Value on the alumina ceramic board (12.5×20×0.7 mm).

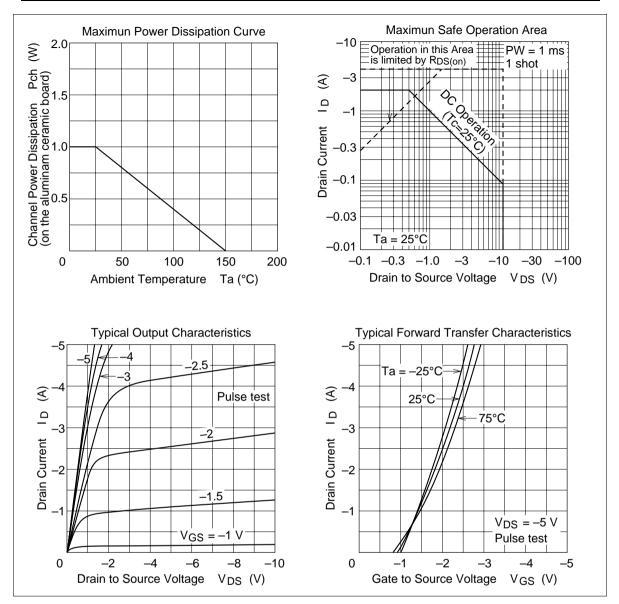
3. Marking is "NY".

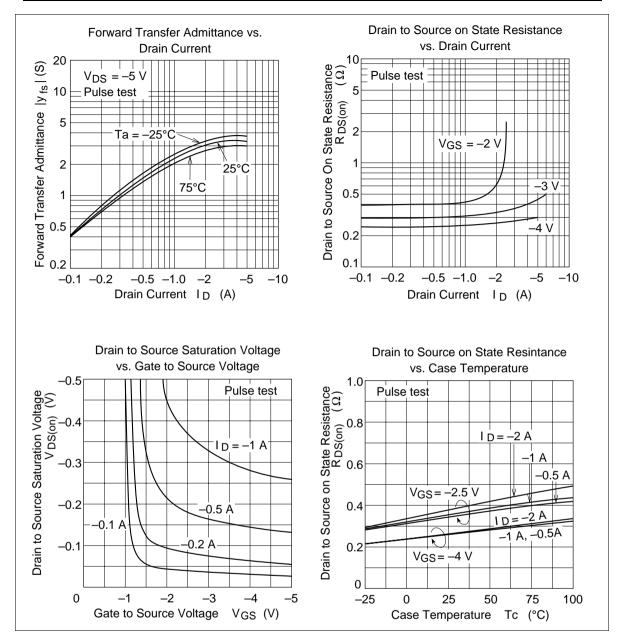
Electrical Characteristics (Ta = 25°C)

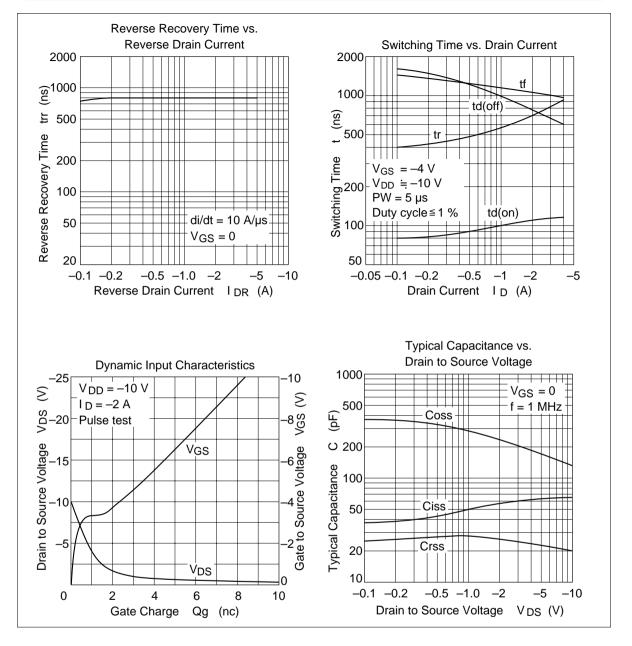
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	-12	_	_	V	$I_{\rm D} = -1$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±7	_	_	V	$I_{g} = \pm 10 \ \mu A, \ V_{DS} = 0$
Gate to source cutoff current	I _{GSS}	—	—	±5	μA	$V_{GS} = \pm 6.5 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	-1	μA	$V_{\rm DS} = -8 \rm V, V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	-0.4	—	-1.4	V	$I_{\rm D} = -100 \ \mu A, \ V_{\rm DS} = -5 \ V$
Static drain to source on state	$R_{\text{DS(on)1}}$	—	0.4	0.7	Ω	$I_{\rm D} = -0.5 \ {\rm A^{*1}}, \ V_{\rm GS} = -2.2 \ {\rm V}$
resistance	R _{DS(on)2}	—	0.28	0.35	Ω	$I_{\rm D} = -1 \ {\rm A^{*1}}, \ V_{\rm GS} = -4 \ {\rm V}$
Forward transfer admittance	y _{fs}	1.0	2.3	_	S	$I_{\rm D} = -1 \ {\rm A}^{*1}, \ {\rm V}_{\rm DS} = -5 \ {\rm V}$
Input capacitance	Ciss	—	63	—	pF	$V_{\rm DS} = -5 V, V_{\rm GS} = 0,$
Output capacitance	Coss	—	180		pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	23		pF	
Turn-on time	t _{on}	_	500		ns	$I_{\rm D} = -0.2 \ {\rm A^{*1}}, \ {\rm Vin} = -4 \ {\rm V},$
Turn-off time	t _{off}	—	2860		ns	R _L = 51 Ω

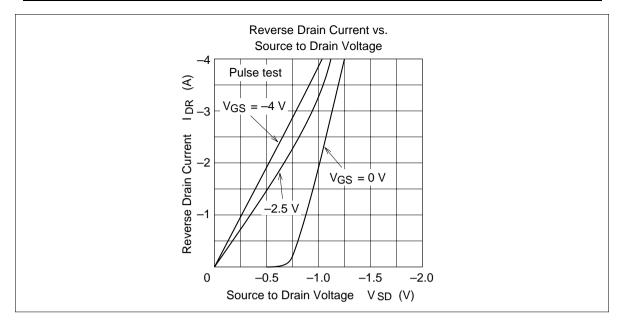
Note: 1. Pulse test



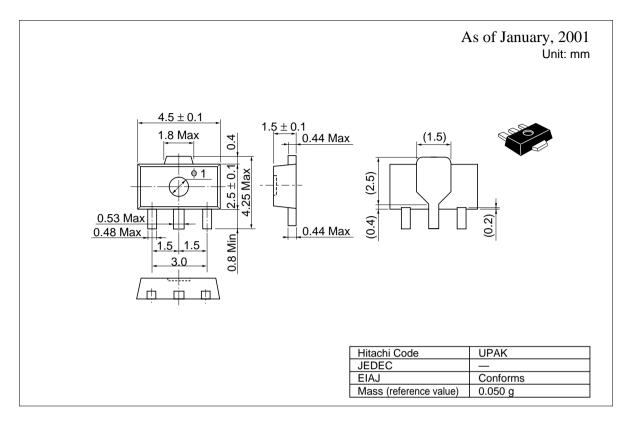








Package Dimensions



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